

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SOON SEOK KIM	05/08/2014
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<b>Postal Code:</b>	413-821
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14356898
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<b>DATE SIGNED:</b>	05/08/2014
<b>Total Attachments: 1</b>	

PATENT



ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the undersigned:

**KIM, Soon Seok**

Of address : 154 Deungwon-ri, Jori-eup Paju-si Gyeonggi-do 413-821, South Korea

(hereinafter called the "assignor(s)"), hereby sell(s), assign(s) and transfer(s) to:

**KIM, Soon Seok**

Of address : 154 Deungwon-ri, Jori-eup Paju-si Gyeonggi-do 413-821, South Korea

And to:

**IDA CO., LTD.**

Of address : 154 Deungwon-ri, Jori-eup Paju-si Gyeonggi-do 413-821, South Korea

(hereinafter called the "assignee(s)"), its/his successors, assignees, nominees or other legal representatives, the assignor's entire right, title and interest in and to the invention entitled:

WINDOWS AND DOORS ASSEMBLY STRUCTURE HAVING A JOINT PORTION OF 45  
DEGREES

described and claimed in the following patent applications:

U.S. Patent Application identified as Attorney Docket No. 5520/3, submitted herewith/filed \_\_\_\_\_

and in and to said Patent Applications, and all original and reissued Patents granted therefore, and all divisions and continuations thereof, including the right to apply and obtain Patents in all other countries, the priority rights under International Conventions, and the Letters Patent which may be granted thereon.

Signed and sealed this 8<sup>th</sup> day of May 2014



**KIM, Soon Seok**